

Single-Channel Power Distribution Switch

Description

The FP6861C is a cost-effective, low voltage, single N-Channel MOSFET high-side power switch, optimized for self-powered and bus-powered Universal Serial Bus (USB) applications.

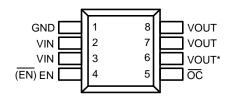
The FP6861C is equipped with a charge pump circuitry to drive the internal MOSFET switch. The switch's low $R_{DS(ON)}$ meets USB voltage drop requirement, and a flag output is available to indicate fault conditions to the local USB controller.

Additional features include soft-start to limit inrush current during plug-in, thermal shutdown to prevent catastrophic switch failure from high-current loads, and Under-Voltage Lockout (UVLO) to ensure that the device remains off unless there is a valid input voltage present. Besides, fault current is limited to specific current for FP6861C in single port in accordance with the USB power requirements. FP6861C will prevent reverse current when it is disabled and V_{OUT} is higher than V_{IN} .

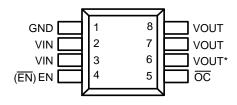
The FP6861C is available in MSOP-8, SOP-8 and SOT-23-5 packages with smallest components.

Pin Assignments

MS Package: MSOP-8



SO Package: SOP-8



^{*} The pin 6 should be considered as VOUT when circuit design and PCB layout, but it is NC pin actually.

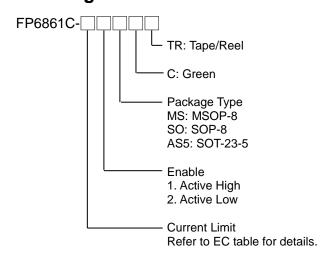
Features

- Compliant to USB Specifications
- Built-In Low R_{DS(ON)} N-Channel MOSFET
- Output can be Forced Higher than Input (Off-State)
- Low Supply Current:
 65µA Typical at Switch On State
 0.1µA Typical at Switch Off State
- Wide Input Voltage Ranges: 2.7V to 5.5V
- Open-Drain Fault Flag Output
- Hot Plug-In Application (Soft-Start)
- 2.2V Typical Under-Voltage Lockout (UVLO)
- Current Limit Protection
- Thermal Shutdown Protection
- Reverse Current Flow Blocking (No Body Diode)
- Logic Level Enable Pin
- MSOP-8, SOP-8 and SOT-23-5 Packages
- RoHS Compliant
- UL NO.E322418 (Approved model: FP6861 series)
- CB Test Certified, Ref. Certif. No. JPTUV-101402

Applications

- USB Bus/Self Powered Hub
- USB Peripheral
- ACPI Power Distribution
- Notebook, Motherboard PC
- Battery-Charger Circuit

Ordering Information



^{**} Please see the Available Product List in next page.

1



AS5 Package: SOT-23-5

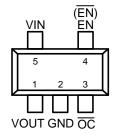


Figure 1. Pin Assignment of FP6861C

Available Product List

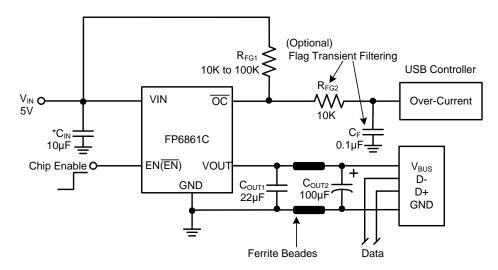
FP6861C-C2SOCTR
FP6861C-E1AS5CTR
FP6861C-E1MSCTR
FP6861C-E2AS5CTR
FP6861C-F1MSCTR
FP6861C-F1SOCTR
FP6861C-H1MSCTR
FP6861C-H1SOCTR
FP6861C-I1AS5CTR
FP6861C-I1SOCTR
FP6861C-I2AS5CTR
FP6861C-J1AS5CTR
FP6861C-J2AS5CTR

SOT-23-5 Marking

301 20 0 Marking						
Part Number	Product Code	Part Number	Product Code			
FP6861C-A1AS5C	A9G	FP6861C-E1AS5C	A3A			
FP6861C-A2AS5C	A4A	FP6861C-E2AS5C	A8A			
FP6861C-B1AS5C	A0G	FP6861C-I1AS5C	F2G			
FP6861C-B2AS5C	A5A	FP6861C-I2AS5C	GA6			
FP6861C-C1AS5C	A1A	FP6861C-J1AS5C	GA4			
FP6861C-C2AS5C	A6A	FP6861C-J2AS5C	FZ6			



Typical Application Circuit



^{*}Note: In most applications, adding one 1µF capacitor is enough. If the trace to VIN is long in PCB, placing larger input capacitor is needed.

Figure 2. Typical Application Circuit

Functional Pin Description

Pin Name	Pin Function
VIN	Input power supply.
VOUT	Switch output.
GND	Ground.
EN	Chip enable. Pull the pin high to enable IC; Pull the pin low to shutdown IC. Do not let the pin floating.
EN	Chip shutdown. Pull the pin high to shutdown IC; Pull the pin low to enable IC. Do not let the pin floating.
OC	Open-drain fault flag output.



Block Diagram

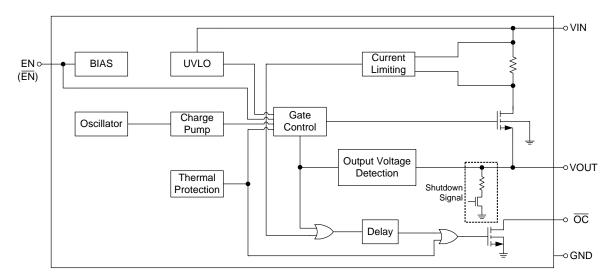


Figure 3. Block Diagram

Absolute Maximum Ratings (Note 1)

• VIN, VOUT	0.3V to +6V
• EN (EN)	0.3V to +6V
• OC	0.3V to +6V
 Power Dissipation @T_J=125°C & T_A=25°C (P_D) 	
MSOP-8 0).63W
SOP-8 0).91W
SOT-23-5 0).4W
 Package Thermal Resistance (θ_{JA}) 	
MSOP-8 1	160°C/W
SOP-8 1	I10°C/W
SOT-23-5 2	250°C/W
• Junction Temperature	+150°C
• Lead Temperature (Soldering,10 sec.)	⊦260°C
Storage Temperature Range	65°C to +150°C
Note 1: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage	to the device.

Recommended Operating Conditions

- Supply Voltage (V_{IN}) ------ +2.7V to +5.5V



Electrical Characteristics

(V_{IN}=5V, T_A=25°C, unless otherwise specified.)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit	
Switch On Resistance	R _{DS(ON)}	I _{OUT} =70% Minimum Current Limit		70	100	mΩ	
	I _{SW_ON}	Switch on, V _{OUT} =Open		65			
Switch On Resistance Isw_or	I _{SW_OFF}	Switch off, V _{OUT} =Open		0.1	1	μA	
CN Throphold	VIL	Switch off			0.7	V	
EN Threshold V _{IH}		Switch on	1.5			V	
EN Input Current	I _{EN}	V _{EN} =Enable		0.01	0.1	μA	
		R _{LOAD} =1Ω, FP6861C-A	2.1	2.45	2.8		
		R _{LOAD} =1Ω, FP6861C-B	1.5	1.75	2.1		
		R _{LOAD} =1Ω, FP6861C-C	0.7	1	1.28		
Current Limit	1	R _{LOAD} =1Ω, FP6861C-E	1.1	1.4	1.7		
	ILIM	R _{LOAD} =1Ω, FP6861C-F	2.5	2.95	3.4	A	
		R _{LOAD} =1Ω, FP6861C-H	3	3.5	4		
		R _{LOAD} =1Ω, FP6861C-I	0.55	0.775	1		
		R _{LOAD} =1Ω, FP6861C-J	1	1.25	1.5		
		VOUT=0V, Measured Prior to Thermal Shutdown FP6861C-A		1.47			
		VOUT=0V, Measured Prior to Thermal Shutdown FP6861C-B		1.05			
	K I _{SC_FB}	VOUT=0V, Measured Prior to Thermal Shutdown FP6861C-C		0.6			
Short Circuit Fold-Back		VOUT=0V, Measured Prior to Thermal Shutdown FP6861C-E		0.84			
Current		VOUT=0V, Measured Prior to Thermal Shutdown FP6861C-F		1.77		A	
		VOUT=0V, Measured Prior to Thermal Shutdown FP6861C-H		2.1			
		VOUT=0V, Measured Prior to Thermal Shutdown FP6861C-I		0.465			
		VOUT=0V, Measured Prior to Thermal Shutdown FP6861C-J		0.75			
Output Leakage Current	I _{LEAKAGE}	VEN=Disable, RLOAD=0Ω		0.5	1	μΑ	
Output Turn-On Rise Time	T _{ON_RISE}	10% to 90% of VOUT Rising,		2	3	ms	



Electrical Characteristics (Continued)

(V_{IN}=5V, T_A=25°C, unless otherwise specified.)

Parameter	Parameter Symbol Conditions		Min	Тур	Max	Unit
OC Output Resistance	R _{oc}	I _{SINK} =1mA		100		Ω
OC Off Current	I _{oc}	V _{OC} =5V		0.01		μA
OC Delay Time	t₀	From Fault Condition to OC Assertion	5	10	20	ms
Under-Voltage Lockout	Vuvlo	V _{IN} Increasing	1.95	2.2	2.45	V
Under-Voltage Hysteresis	ΔV_{UVLO}	V _{IN} Decreasing		0.2		V
Shutdown Pull Low Resistance	R _{PD}			80		Ω
Thermal Shutdown	T _{SD}			150		°C
Threshold (Note 2)	ΔT _{SD}	Hysteresis		30		°C

Note 2: Guarantee by design.



Test Circuit

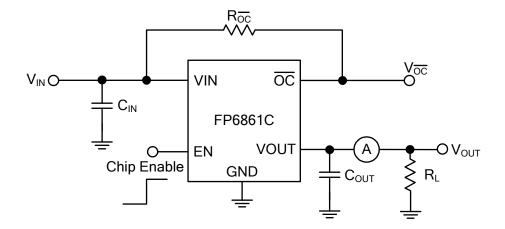


Figure 4. Electrical Characteristic Test Circuit of FP6861C



Typical Performance Curves

 $V_{\text{IN}} = V_{\text{OUT}} = 5V$, $C_{\text{IN}} = 100 \mu\text{F}$, $C_{\text{OUT}} = 120 \mu\text{F}$, TA=+25°C, unless otherwise noted. This is measured by using FP6861C-J1AS5C.

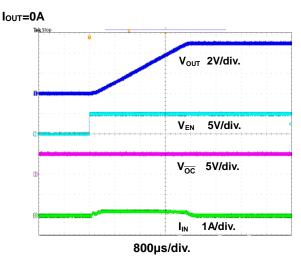


Figure 5. EN Start-Up

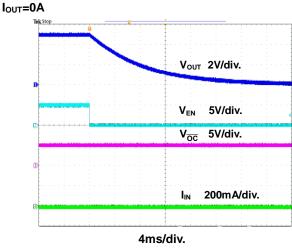


Figure 7. EN Power Off Test

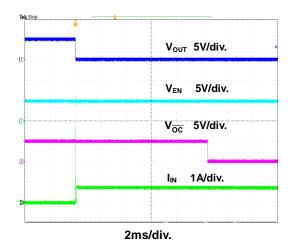
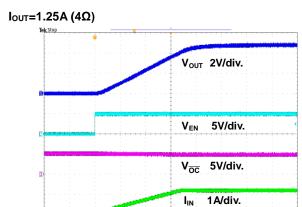


Figure 9. Inrush Short Circuit Response



800µs/div. Figure 6. EN Start-Up

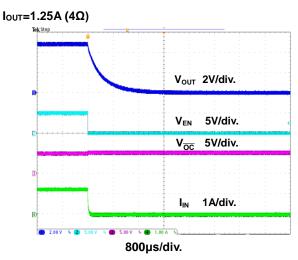


Figure 8. EN Power Off Test

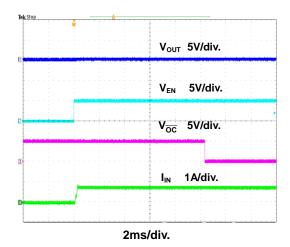


Figure 10. Short Circuit Response at Start Up



Typical Performance Curves (Continued)

 $V_{\text{IN}} = V_{\text{OUT}} = 5V, \ C_{\text{IN}} = 100 \mu\text{F}, \ C_{\text{OUT}} = 120 \mu\text{F}, \ TA = +25 ^{\circ}\text{C}, \ unless otherwise noted.} \ This is measured by using FP6861C-J1AS5C.$

IOUT=0A~1.25A

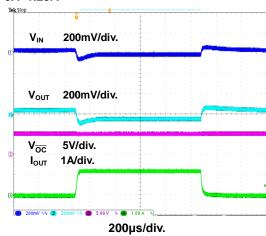


Figure 11. Load Transient

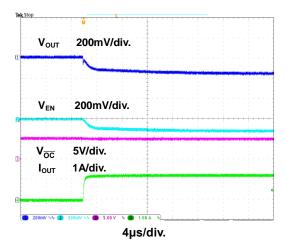
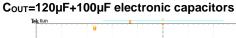


Figure 13. Output Load Insert Hot Plug-In with 4Ω (1.25A)



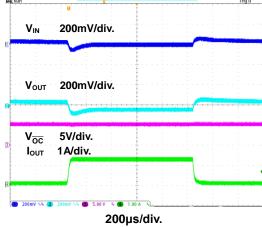


Figure 12. Load Transient

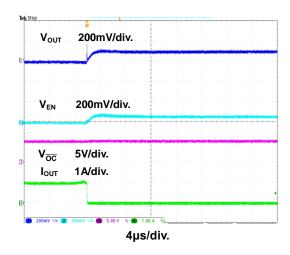


Figure 14. Output Load Insert Hot Plug-Off with 4Ω (1.25A)

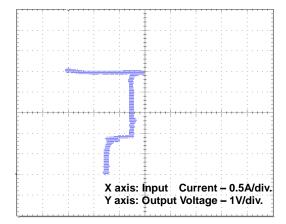


Figure 15. Over Current Protection Characteristics



Typical Performance Curves (Continued)

 $V_{\text{IN}} = V_{\text{OUT}} = 5\text{V}, \ C_{\text{IN}} = 100 \mu\text{F}, \ C_{\text{OUT}} = 120 \mu\text{F}, \ T\text{A} = +25^{\circ}\text{C}, \ unless otherwise noted.} \ This is measured by using FP6861C-J1AS5C.$

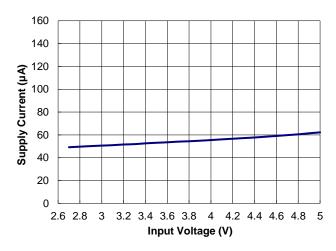


Figure 16. Supply Current vs. Input Voltage

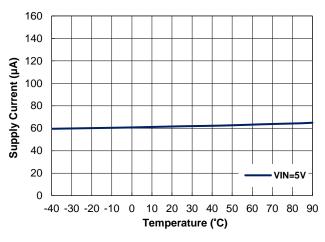


Figure 18. Supply Current vs. Temperature

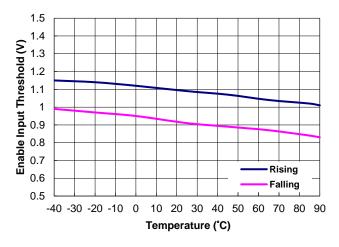


Figure 20. Enable Input Threshold vs. Temperature

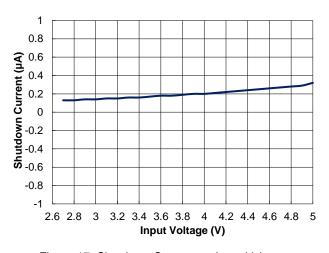


Figure 17. Shutdown Current vs. Input Voltage

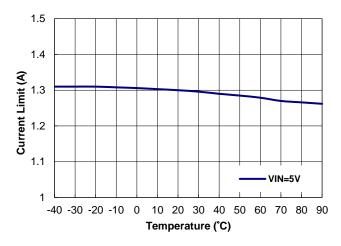


Figure 19. Current Limit vs. Temperature



Application Information

The FP6861C is a single N-Channel MOSFET high-side power switch, optimized for self-powered and bus-powered Universal Serial Bus (USB) applications. The FP6861C operates from 2.7V to 5.5V input voltage range and provides low supply current. The switch's low $R_{\rm DS(ON)},\,70{\rm m}\Omega,$ meets USB voltage drop requirements. It has one switch with enable control input. The switch has an error flag output to notify the USB controller when the current-limit, short-circuit or thermal-shutdown occurs.

Under-Voltage Lockout

Under-Voltage Lockout (UVLO) prevents the MOSFET switch from turning on until input voltage exceeds approximately 2.2V. If input voltage drops below approximately 2V, UVLO will turn off the MOSFET switch.

Thermal Shutdown

Thermal shutdown is employed to protect the device from damage if the die temperature exceeds safe margins mainly due to short-circuit or current-limit. Thermal shutdown will shut the switch off and cause the \overline{OC} output to go low.

Reverse Current Blocking

The USB specification does not allow an output device to source current back into the USB port. However, the FP6861C is designed to safely power noncompliant devices. When the device is disabled, the output will be switched to a high-impedance state, blocking reverse current flow from the output back to the input. The switch is bidirectional when it is enabled.

Error Flag

The FP6861C provides an open drain error flag output for the switch. For most applications, connect \overline{OC} to VIN through a pull-up resistor. \overline{OC} will go low when any following condition occurs:

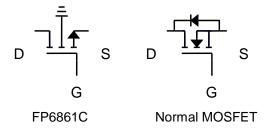
- a. The thermal shutdown occurs.
- b. The switch is in current limit or short circuit conditions.

Fast Shutdown Load Discharge

The FP6861C provides a pull down resistance when the device is off. The resistance could discharge the load capacitor fast (refer to the block diagram).

Input and Output

VIN is the power source connection to the internal circuitry and the drain of the MOSFET. VOUT is the source of the MOSFET. In typical application, current flows through the switch from VIN to VOUT toward the load. If VOUT is greater than VIN, current will flow from VOUT to VIN since the MOSFET is bidirectional. There is no parasitic body diode between drain and source of the MOSFET, and the FP6861C will prevent reverse current flow if VOUT externally forces a higher voltage than VIN when the output is disabled.



Soft Start for Hot Plug-In Application

In order to eliminate the upstream voltage drop caused by the large inrush current during hot-plug events, the "soft-start" feature effectively isolates the power source from extremely large capacitive loads, satisfying the USB voltage drop requirements.

Current Limit and Short-Circuit Protection

The current limit circuitry prevents damage to the MOSFET switch and the hub downstream port but can deliver load current up to the current limit threshold through the switch of FP6861C. When a heavy load or short circuit is applied to an enabled switch, a large transient current may flow until the current limit circuitry responds. Once exceeds the current limit threshold, the device will enter constant current mode until the thermal shutdown occurs or the fault is removed.



Application Information (Continued)

Supply Filter/Bypass Capacitor

The input capacitor must be at least $1\mu F$ low-ESR ceramic capacitor connected from VIN to GND, but can be increased without limit. Output short may cause sufficient ringing on the input (from source lead inductance) to destroy the internal control circuitry. The input transient must not exceed 6V of the absolute maximum supply voltage even for a short duration.

Output Filter Capacitor

Output is recommended to use a $22\mu F$ ceramic capacitor in parallel with a $100\mu F$ electrolytic capacitor. Standard bypass methods should be used to minimize inductance and resistance between the bypass capacitor and the downstream connector which reduce EMI and decouple voltage drop caused when downstream cables are hot-insertion transients. Ferrite beads in series with V_{BUS} , the ground line and the $0.1\mu F$ bypass capacitors at the power connector pins are recommended for EMI and ESD protection. The bypass capacitor should have a low dissipation factor to allow decoupling at higher frequencies.

Power Dissipation

The device's junction temperature depends on several factors, such as the load, PCB layout, ambient temperature and package type. However, the maximum output current must be decreased at higher ambient temperature to ensure the junction temperature does not exceed 150°C. With all possible conditions, the junction temperature must be within the range specified under operating conditions. Power dissipation can be calculated based on the output current and the R_{DS(ON)} of switch as below:

$$P_D = R_{DS(ON)} \times (I_{OUT})^2$$

Although the devices are rated by current limit, but the application may limit the amount of output current based on the total power dissipation and the ambient temperature. The final operating junction temperature for any set of conditions can be estimated by the following thermal equation:

$$P_{D(MAX)} = \frac{T_{J(MAX)} - T_A}{\theta_{JA}}$$

Where $T_{J(MAX)}$ is the maximum junction temperature 125°C, T_A is the ambient temperature and the θ_{JA} is the junction to ambient thermal resistance.

The junction to ambient thermal resistance θ_{JA} is related to layout. For SOT-23-5 package, the thermal resistance θ_{JA} is 250°C/W on the standard JEDEC 51-3 single-layer thermal test board.

PCB Layout

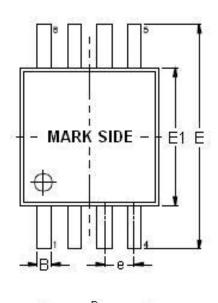
In order to meet the voltage drop and EMI requirements, careful PCB layout is necessary. The following guidelines must be considered:

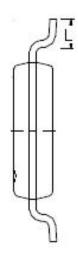
- 1. Keep all V_{BUS} traces as short as possible, and use at least 50-mil and 2 ounce copper for all V_{BUS} traces.
- 2. Locate the FP6861C as close to the output port as possible to limit switching noise.
- 3. Locate the ceramic bypass capacitors as close to the VIN pins of the FP6861C as possible.
- 4. Avoid vias as much as possible. If vias are necessary, make them as large as feasible.
- 5. Place a ground plane under all circuitry to lower both resistance and inductance, and improve DC and transient performance (use a separate ground and power plans if possible).
- 6. Place cuts in the ground plane between ports to help reducing the coupling of transients between ports.
- Locate the output capacitor and ferrite beads as close to the USB connectors as possible to lower impedance (mainly inductance) between the port and the capacitor, and improve transient load performance.



Outline Information

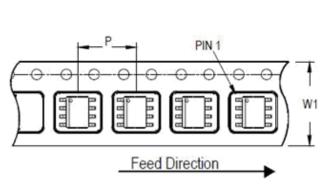
MSOP-8 Package (Unit: mm)

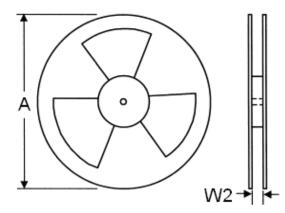




SYMBOLS	DIMENSION IN	MILLIMETER
UNIT	MIN	MAX
Α	0.75	1.10
A1	0.00	0.15
A2	0.75	0.95
В	0.25	0.35
D	2.90	3.10
E	4.80	5.00
E1	2.90	3.10
е	0.60	0.70
Ĺ	0.40	0.80

Carrier Dimensions



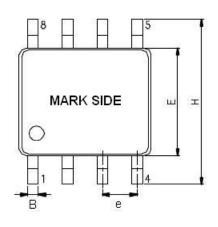


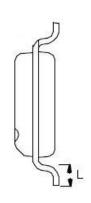
Tape Size	Pocket Pitch	Reel Size (A)		Reel Width	Empty Cavity	Units per Reel
(W1) mm	(P) mm	in	mm	(W2) mm	Length mm	
12	8	13	330	12.4	400~1000	3,000



Outline Information (Continued)

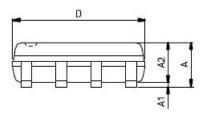
SOP-8 Package (Unit: mm)



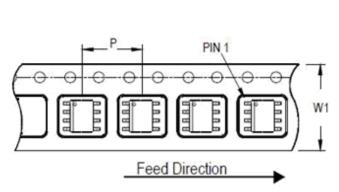


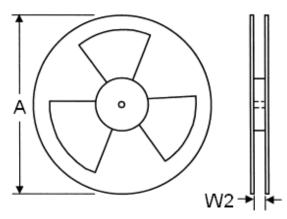
SYMBOLS	DIMENSION IN MILLIMETER					
UNIT	MIN	MAX				
Α	1.35	1.75				
A1	0.10	0.25				
A2	1.25	1.50				
В	0.31	0.51				
D	4.80	5.00				
Е	3.80	4.00				
е	1.20	1.34				
Н	5.80	6.20				
L	0.40	1.27				

Note 3: Followed From JEDEC MO-012-E.



Carrier Dimensions



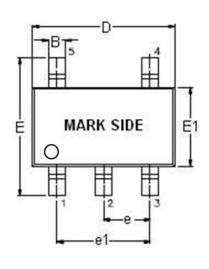


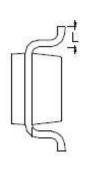
Tape Size	Pocket Pitch	ReelS	ize (A)	Reel Width	Empty Cavity	Units per Reel
(W1) mm	(P) mm	in	mm	(W2) mm	Length mm	
12	8	13	330	12.4	400~1000	2,500

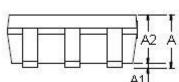


Outline Information (Continued)

SOT-23-5 Package (Unit: mm)



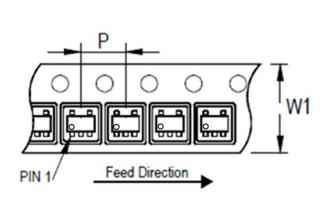


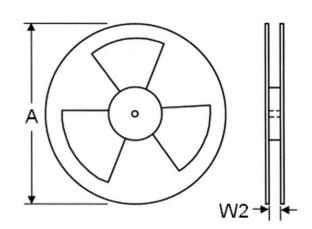


SYMBOLS	DIMENSION IN MILLIMETER				
UNIT	MIN	MAX			
Α	0.90	1.45			
A1	0.00	0.15			
A2	0.90	1.30			
В	0.30	0.50			
D	2.80	3.00			
E	2.60	3.00			
E1	1.50	1.70			
е	0.90	1.00			
e1	1.80	2.00			
L	0.30	0.60			

Note 4: Followed From JEDEC MO-178-C. Note 5: Dimensions D and E1 are exclusive of mold flash, protrusions, or gate burrs which less than 0.3mm.

Carrier Dimensions





Tape Size	Pocket Pitch	Reel Size (A)		Reel Width	Empty Cavity	Units per Reel
(W1) mm	(P) mm	in	mm	(W2) mm	Length mm	
8	4	7	180	8.4	300~1000	3,000

Life Support Policy

Fitipower's products are not authorized for use as critical components in life support devices or other medical systems.